

DESCRIPTION

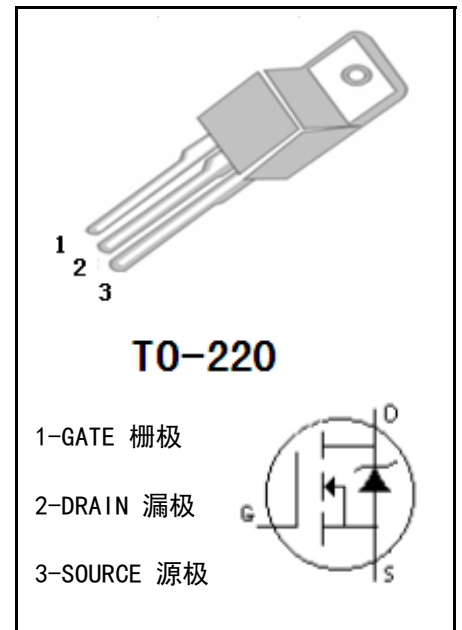
- ELECTRONIC BALLAST
- ELECTRONIC TRANSFORMER
- SWITCH MODE POWER SUPPLY

FEATURES:

- LOW THERMAL RESISTANCE
- HIGH INPUT RESISTANCE
- FAST SWITCHING
- ROHS COMPLIANT

MAXIMUM RATINGS (T_c=25°C)

PARAMETER	SYMBOL	VALUE	UNIT
Drain-source Voltage	VDS	60	V
gate-source Voltage	VGS	±20	V
Continuous Drain Current	ID	60	A
Drain Current-Pulsed	IDM	240	A
Total Dissipation	PD	75	W
Junction Temperature	T _j	150	°C
Storage Temperature Range	T _{stg}	-55-150	°C
Single Pulse Avalanche Energy (L=0.5mH)	EAS	125	mJ

MECHANICAL

ELECTRONIC CHARACTERISTICS (T_c=25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	MAX	UNIT
Drain-source Breakdown Voltage	BVDSS	VGS=0V, ID=250 μA	60		V
Gate Threshold Voltage	VGS (TH)	VGS=VDS, ID=250 μA	1	2.4	V
Drain-source Leakage Current	IDSS	VDS=48V, VGS=0V		1	uA
Drain-Source Diode Forward Voltage	VSD	VGS=0V, IS=10A		1.2	V
Gate-body Leakage Current (VDS = 0)	IGSS	VGS=±20V		±100	nA
Static Drain-source On Resistance	RDS (ON)	VGS=4.5V, ID=20A		13	mΩ
		VGS=10V, ID=20A		9	mΩ
Thermal Resistance Junction-case	RthJ-c			2	°C/W

■ DYNAMIC CHARACTERISTICS (T_c=25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Input Capacitance	C _{iss}	V _{DS} =35V, V _{GS} =0V, f=1.0MHz	-	1650	-	pF
output Capacitance	C _{oss}		-	400	-	pF
Reverse Transfer Capacitance	C _{rss}		-	5	-	pF
Gate resistance	R _G	V _{DS} =0V, V _{GS} =0V, f=1.0MHz	-	2.5	-	Ω

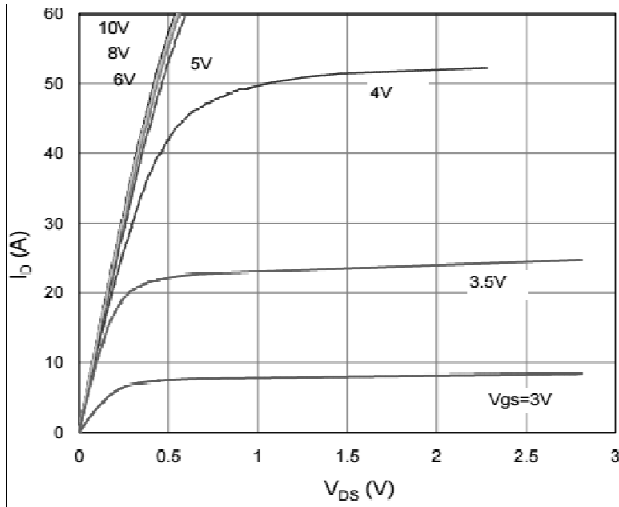
■ SWITCHING CHARACTERISTICS (T_c=25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Turn-On Delay Time	t _{d(on)}	V _{DD} =30V, I _D =20A, V _{GS} =10V, R _G =3Ω	-	9	-	ns
Turn-On Rise Time	t _r		-	4	-	ns
Turn-Off Delay Time	t _{d(off)}		-	29	-	ns
Turn-Off Rise Time	t _f		-	4	-	ns
Total Gate Charge	Q _g	V _{DS} =30V, I _D =20A, V _{GS} =10V	-	24	-	nC
Gate-Source Charge	Q _{gs}		-	5	-	nC
Gate-Drain Charge	Q _{gd}		-	3	-	nC

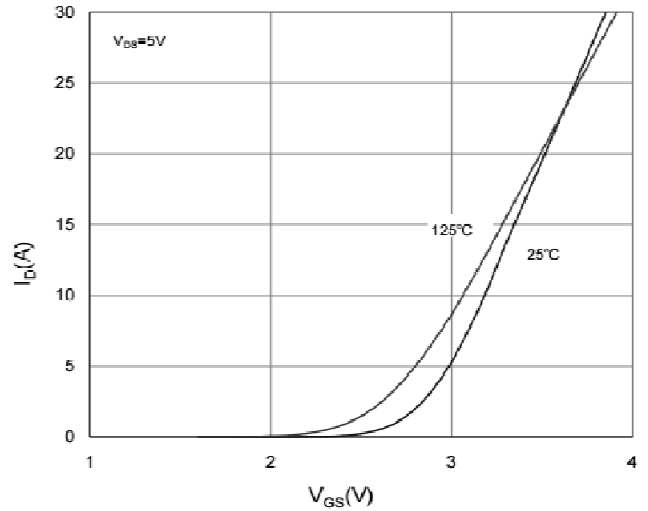
■ DRAIN-SOURCE DIODE MAXIMUM RATINGS AND CHARACTERISTICS (T_c=25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =10A	-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J =25°C, I _F =20A, di/dt=300A/μs	-	30	-	ns
Reverse Recovery Charge	Q _{rr}		-	43	-	nC

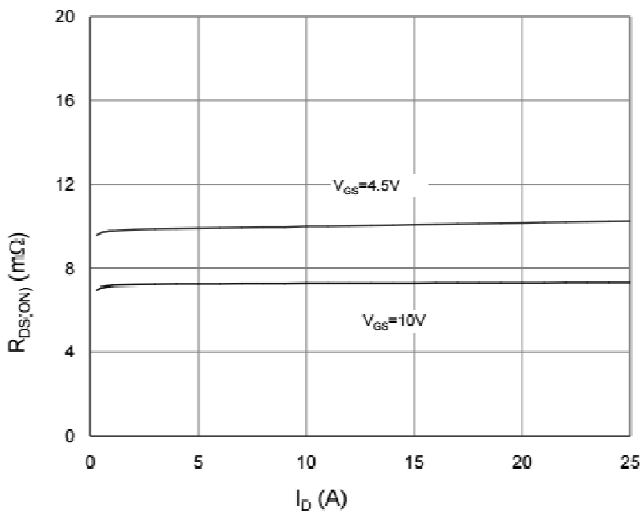
CHARACTERISTICS CURVE



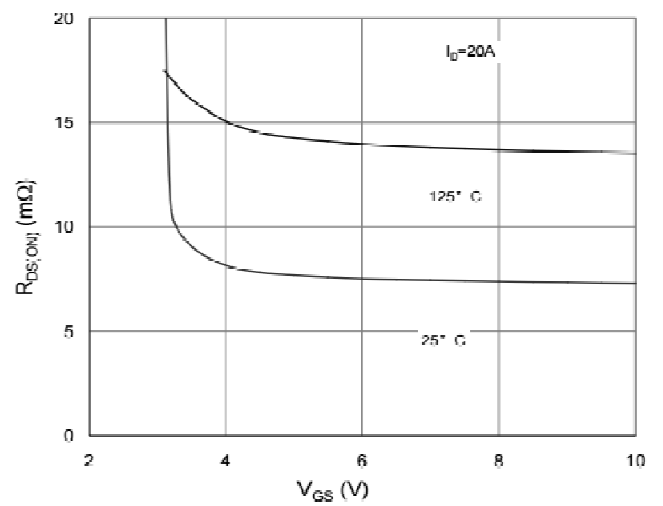
Output Characteristic



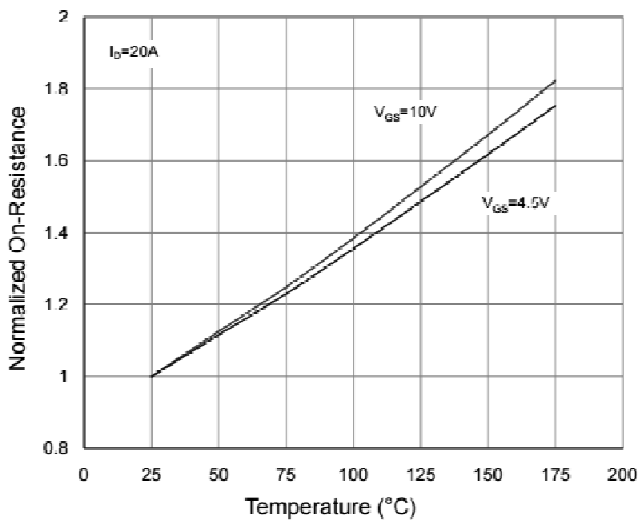
Transfer Characteristic



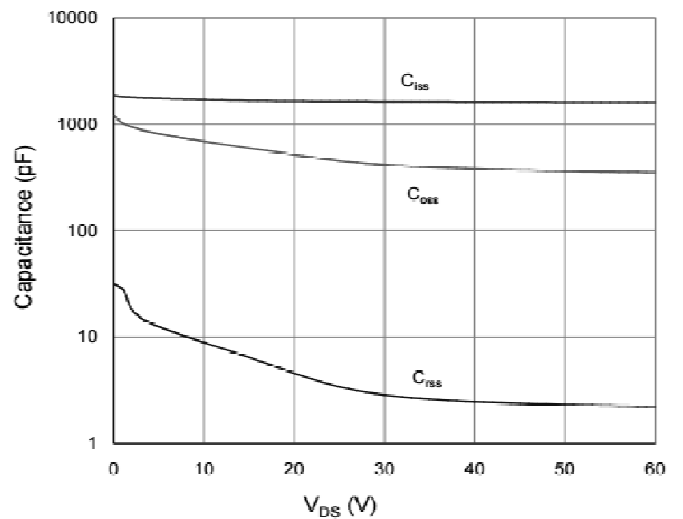
On Resistance Vs Drain Current



On-Resistance vs. Gate-Source Voltage



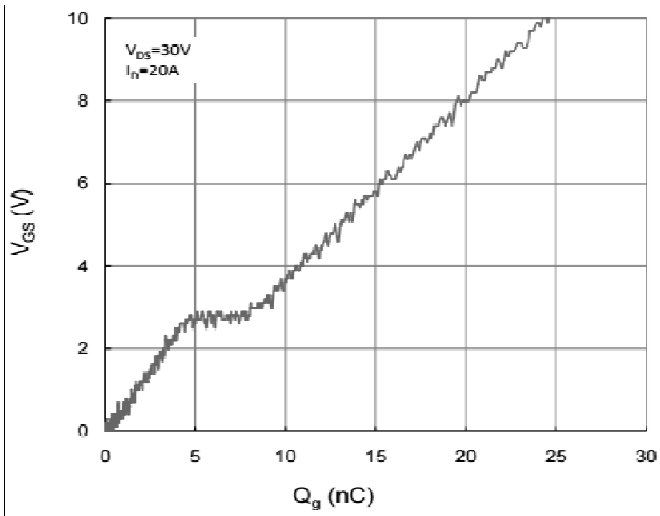
On Resistance Vs Junction Temperature



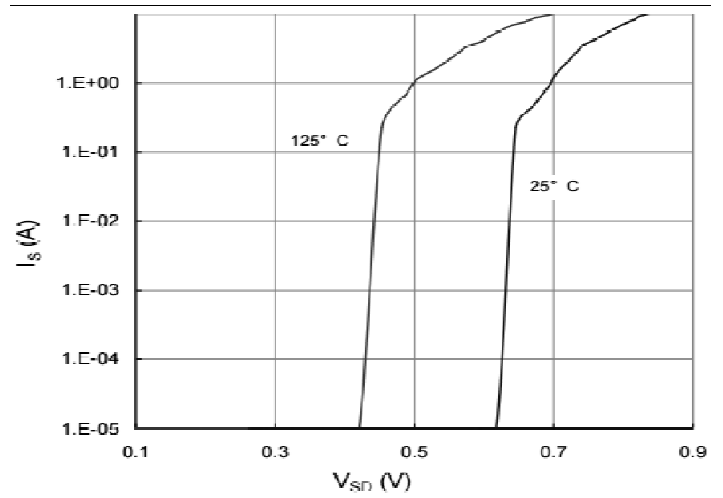
Capacitance



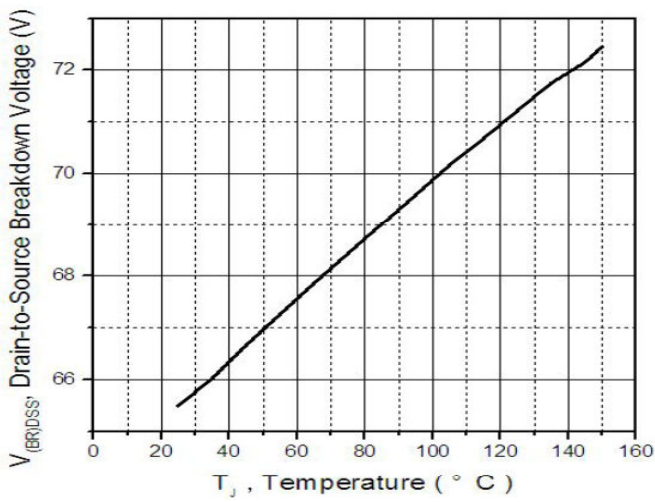
CHARACTERISTICS CURVE



Gate Charge Waveform



Source-Drain Diode Forward Voltage



Breakdown Voltage Vs Junction Temperature

TO-220 MECHANICAL DATA

UNIT: mm

SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4		4.8	e	2.44	2.54	2.64
B	1.2		1.4	F	1.1		1.4
B1	1		1.4	L	12.5		14.5
b1	0.75		0.95	L1	3	3.5	4
c	0.4		0.55	ΦP	3.7	3.8	3.9
D	15		16.5	Q	2.5		3
D1	5.9		6.9	Q1	2		2.9
E	9.9		10.7				

